Notification Number:	20151117000	Notification Date:	11/19/2015
Title:	Datasheet update for LM5160-Q1		
Customer Contact:	PCN Manager	**Dept:**	Quality Services

Change Type:

☐ Assembly Site	☐ Design	☐ Wafer Bump Site
☐ Assembly Process	☒ Data Sheet	☐ Wafer Bump Material
☐ Assembly Materials	☐ Part number change	☐ Wafer Bump Process
☐ Mechanical Specification	☐ Test Site	☐ Wafer Fab Site
☐ Packing/Shipping/Labeling	☐ Test Process	☐ Wafer Fab Materials
		☐ Wafer Fab Process

Notification Details

Description of Change:

Texas Instruments Incorporated is announcing an information only notification.

The product datasheet(s) is updated as seen in the change revision history below:

LM5160-Q1

SNVSAE4A – JULY 2015 – REVISED NOVEMBER 2015   www.ti.com

Changes from Original (July 2015) to Revision A   **Page**

• Changed current limit off-timer in the Electrical Characteristics to 16...6

The datasheet number will be changing.

Device Family	Change From:	Change To:
LM5160-Q1	SNVSAE4	**SNVSAE4A**

These changes may be reviewed at the datasheet links provided.

http://www.ti.com/product/lm5160-q1

Reason for Change:

To more accurately reflect device characteristics.

Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):

No anticipated impact. This is a specification change announcement only. There are no changes to the actual device.

Changes to product identification resulting from this Notification:

None.

Product Affected:

LM5160AQPWPQ1	LM5160AQPWPTQ1	LM5160QPWPRQ1	PLM5160AQPWPQ1
LM5160AQPWPRQ1	LM5160QPWPQ1	LM5160QPWPTQ1	PLM5160QPWPTQ1

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
Japan	PCNJapanContact@list.ti.com